

# Octal 3-State Inverting Transceiver

## MC74ACT640

The MC74ACT640 octal bus transceiver is designed for asynchronous two-way communication between data buses. The device transmits data from bus  $\bar{A}$  to bus B when  $T/\bar{R} = \text{HIGH}$ , or from bus  $\bar{B}$  to bus A when  $T/\bar{R} = \text{LOW}$ . The enable input can be used to disable the device so the buses are effectively isolated.

### Features

- Bidirectional Data Path
- A and B Outputs Sink 24 mA/Source -24 mA
- TTL Compatible Inputs
- These are Pb-Free Devices

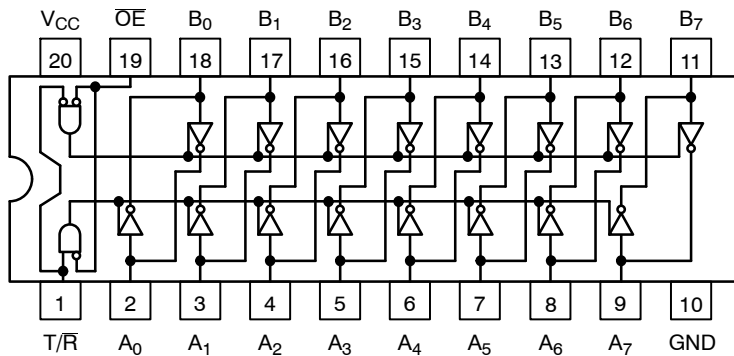


Figure 1. Pinout: 20-Lead Packages Conductors  
(Top View)

### PIN ASSIGNMENT

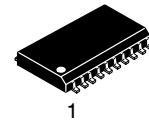
| PIN                            | FUNCTION                         |
|--------------------------------|----------------------------------|
| A <sub>0</sub> –A <sub>7</sub> | Side A Inputs or 3-State Outputs |
| $\overline{OE}$                | Output Enable Input              |
| T/ $\bar{R}$                   | Transmit/Receive Input           |
| B <sub>0</sub> –B <sub>7</sub> | Side B Inputs or 3-State Outputs |

### TRUTH TABLE

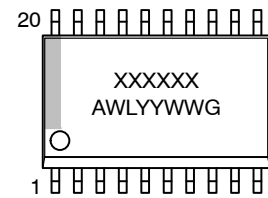
| OE | T/ $\bar{R}$ | Applied Inputs | Valid Direction I/P→O/P | Output |
|----|--------------|----------------|-------------------------|--------|
| H  | X            | X              | X                       | X      |
| L  | H            | H              | $\bar{A}$ to B          | L      |
| L  | H            | L              | $\bar{A}$ to B          | H      |
| L  | L            | H              | $\bar{B}$ to A          | L      |
| L  | L            | L              | $\bar{B}$ to A          | H      |

H = HIGH Voltage Level  
L = LOW Voltage Level  
X = Immaterial

### MARKING DIAGRAMS



1  
SOIC-20W  
DW SUFFIX  
CASE 751D



XXXXXX = Specific Device Code  
A = Assembly Location  
WL = Wafer Lot  
YY = Year  
WW = Work Week  
G = Pb-Free Package  
(Note: Microdot may be in either location)

### ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

# MC74ACT640

## MAXIMUM RATINGS

| Symbol        | Parameter                                       | Value                                                      | Unit                  |
|---------------|-------------------------------------------------|------------------------------------------------------------|-----------------------|
| $V_{CC}$      | DC Supply Voltage (Referenced to GND)           | -0.5 to +6.5                                               | V                     |
| $V_{IN}$      | DC Input Voltage (Referenced to GND)            | -0.5 to $V_{CC}$ +0.5                                      | V                     |
| $V_{OUT}$     | DC Output Voltage (Referenced to GND) (Note 1)  | -0.5 to $V_{CC}$ +0.5                                      | V                     |
| $I_{IK}$      | DC Input Diode Current                          | ±20                                                        | mA                    |
| $I_{OK}$      | DC Output Diode Current                         | ±50                                                        | mA                    |
| $I_{OUT}$     | DC Output Sink/Source Current                   | ±50                                                        | mA                    |
| $I_{CC}$      | DC Supply Current, per Output Pin               | ±50                                                        | mA                    |
| $I_{GND}$     | DC Ground Current, per Output Pin               | ±100                                                       | mA                    |
| $T_{STG}$     | Storage Temperature Range                       | -65 to +150                                                | °C                    |
| $T_L$         | Lead temperature, 1 mm from Case for 10 Seconds | 260                                                        | °C                    |
| $T_J$         | Junction Temperature Under Bias                 | 140                                                        | °C                    |
| $\theta_{JA}$ | Thermal Resistance (Note 2)                     | 96                                                         | °C/W                  |
| MSL           | Moisture Sensitivity                            | Level 1                                                    |                       |
| $F_R$         | Flammability Rating                             | Oxygen Index: 30% – 35%<br>UL 94 V-0 @ 0.125 in            |                       |
| $V_{ESD}$     | ESD Withstand Voltage                           | Human Body Model (Note 3)<br>Charged Device Model (Note 4) | > 2000<br>> 1000<br>V |
| $I_{Latchup}$ | Latchup Performance                             | Above $V_{CC}$ and Below GND at 85°C (Note 5)              | ±100<br>mA            |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1.  $I_{OUT}$  absolute maximum rating must be observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.
3. Tested to EIA/JESD22-A114-A.
4. Tested to JESD22-C101-A.
5. Tested to EIA/JESD78.

## RECOMMENDED OPERATING CONDITIONS

| Symbol            | Parameter                                            | Min                                                          | Typ       | Max       | Unit |
|-------------------|------------------------------------------------------|--------------------------------------------------------------|-----------|-----------|------|
| $V_{CC}$          | DC Input Voltage (Referenced to GND)                 | 4.5                                                          |           | 5.5       | V    |
| $V_{in}, V_{out}$ | DC Input Voltage, Output Voltage (Referenced to GND) | 0                                                            |           | $V_{CC}$  | V    |
| $T_A$             | Operating Temperature, All Package Types             | -40                                                          | 25        | +85       | °C   |
| $t_r, t_f$        | Input Rise and Fall Time (Note 7)                    | $V_{CC} = 4.5\text{ V}$<br>0<br>$V_{CC} = 5.5\text{ V}$<br>0 | 10<br>8.0 | 10<br>8.0 | ns/V |
| $I_{OH}$          | Output Current – High                                |                                                              |           | -24       | mA   |
| $I_{OL}$          | Output Current – Low                                 |                                                              |           | 24        | mA   |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

6. Unused Inputs may not be left open. All inputs must be tied to a high voltage level or low logic voltage level.
7.  $V_{in}$  from 0.8 V to 2.0 V; refer to individual Data Sheets for devices that differ from the typical input rise and fall times.

# MC74ACT640

## DC CHARACTERISTICS

| Symbol                               | Parameter                              | V <sub>CC</sub><br>(V) | T <sub>A</sub> = +25°C |                   | T <sub>A</sub> = -40°C to<br>+85°C | Unit     | Conditions                                                                                                                                  |
|--------------------------------------|----------------------------------------|------------------------|------------------------|-------------------|------------------------------------|----------|---------------------------------------------------------------------------------------------------------------------------------------------|
|                                      |                                        |                        | Typ                    | Guaranteed Limits |                                    |          |                                                                                                                                             |
| V <sub>IH</sub>                      | Minimum High Level Input Voltage       | 4.5<br>5.5             | 1.5<br>1.5             | 2.0<br>2.0        | 2.0<br>2.0                         | V<br>V   | V <sub>OUT</sub> = 0.1 V<br>or<br>V <sub>CC</sub> - 0.1 V                                                                                   |
| V <sub>IL</sub>                      | Maximum Low Level Input Voltage        | 4.5<br>5.5             | 1.5<br>1.5             | 0.8<br>0.8        | 0.8<br>0.8                         | V<br>V   | V <sub>OUT</sub> = 0.1 V<br>or<br>V <sub>CC</sub> - 0.1 V                                                                                   |
| V <sub>OH</sub>                      | Minimum High Level Output Voltage      | 4.5<br>5.5             | 4.49<br>5.49           | 4.4<br>5.4        | 4.4<br>5.4                         | V<br>V   | I <sub>OUT</sub> = -50 μA                                                                                                                   |
|                                      |                                        | 4.5<br>5.5             |                        | 3.86<br>4.86      | 3.76<br>4.76                       | V<br>V   | *V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> -24 mA<br>I <sub>OH</sub> -24 mA                                                      |
| V <sub>OL</sub>                      | Maximum Low Level Output Voltage       | 4.5<br>5.5             | 0.001<br>0.001         | 0.1<br>0.1        | 0.1<br>0.1                         | V<br>V   | I <sub>OUT</sub> = 50 μA                                                                                                                    |
|                                      |                                        | 4.5<br>5.5             |                        | 0.36<br>0.36      | 0.44<br>0.44                       | V<br>V   | *V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> -24 mA<br>I <sub>OH</sub> -24 mA                                                      |
| I <sub>IN</sub>                      | Maximum Input Leakage Current          | 5.5                    |                        | ±0.1              | ±1.0                               | μA       | V <sub>I</sub> = V <sub>CC</sub> , GND                                                                                                      |
| ΔI <sub>CCT</sub>                    | Additional Max. I <sub>CC</sub> /Input | 5.5                    | 0.6                    |                   | 1.5                                | mA       | V <sub>I</sub> = V <sub>CC</sub> - 2.1 V                                                                                                    |
| I <sub>OZ</sub>                      | Maximum 3-State Current                | 5.5                    |                        | ±0.5              | ±5.0                               | μA       | V <sub>I</sub> (OE) = V <sub>IL</sub> , V <sub>IH</sub><br>V <sub>I</sub> = V <sub>CC</sub> , GND<br>V <sub>O</sub> = V <sub>CC</sub> , GND |
| I <sub>OLD</sub><br>I <sub>OHD</sub> | †Minimum Dynamic Output Current        | 5.5<br>5.5             |                        |                   | 75<br>-75                          | mA<br>mA | V <sub>OLD</sub> = 1.65 V Max                                                                                                               |
| I <sub>CC</sub>                      | Maximum Quiescent Supply Current       | 5.5                    |                        | 8.0               | 80                                 | μA       | V <sub>IN</sub> = V <sub>CC</sub> or GND                                                                                                    |

\*All outputs loaded; thresholds on input associated with output under test.

†Maximum test duration 2.0 ms, one output loaded at a time.

## AC CHARACTERISTICS t<sub>r</sub> = t<sub>f</sub> = 3.0 ns (For Figures and Waveforms, See Figures 2 and 3.)

| Symbol           | Parameter                                 | V <sub>CC</sub> *<br>(V) | T <sub>A</sub> = +25°C<br>C <sub>L</sub> = 50 pF |      | T <sub>A</sub> = -40°C to +85°C<br>C <sub>L</sub> = 50 pF |      | Unit |
|------------------|-------------------------------------------|--------------------------|--------------------------------------------------|------|-----------------------------------------------------------|------|------|
|                  |                                           |                          | Min                                              | Max  | Min                                                       | Max  |      |
| t <sub>PLH</sub> | Propagation Delay An to Bn or Bn to An    | 5.0                      | 1.5                                              | 8.0  | 1.0                                                       | 8.5  | ns   |
| t <sub>PHL</sub> | Propagation Delay An to Bn or Bn to An    | 5.0                      | 1.5                                              | 8.0  | 1.0                                                       | 9.0  | ns   |
| t <sub>PZH</sub> | Output Enable Time OE to An or Bn         | 5.0                      | 1.5                                              | 10.0 | 1.0                                                       | 11.0 | ns   |
| t <sub>PZL</sub> | Output Enable Time OE to An or Bn         | 5.0                      | 1.5                                              | 10.0 | 1.0                                                       | 11.0 | ns   |
| t <sub>PHZ</sub> | Output Disable Time T/R or OE to An or Bn | 5.0                      | 1.5                                              | 10.0 | 1.0                                                       | 11.0 | ns   |
| t <sub>PLZ</sub> | Output Disable Time T/R or OE to An or Bn | 5.0                      | 1.5                                              | 10.0 | 1.0                                                       | 11.0 | ns   |

\*Voltage Range 5.0 V is 5.0 V ±0.5 V

## CAPACITANCE

| Symbol           | Parameter                     | Value Typ | Unit | Test Conditions         |
|------------------|-------------------------------|-----------|------|-------------------------|
| C <sub>IN</sub>  | Input Capacitance             | 4.5       | pF   | V <sub>CC</sub> = 5.0 V |
| C <sub>I/O</sub> | Input/Output Capacitance      | 15        | pF   | V <sub>CC</sub> = 5.0 V |
| C <sub>PD</sub>  | Power Dissipation Capacitance | 45        | pF   | V <sub>CC</sub> = 5.0 V |

# MC74ACT640

## SWITCHING WAVEFORMS

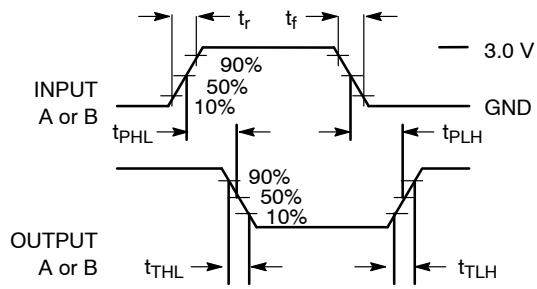


Figure 2.

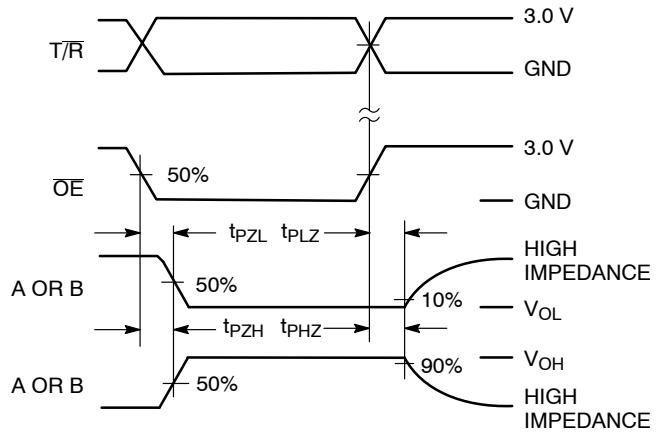
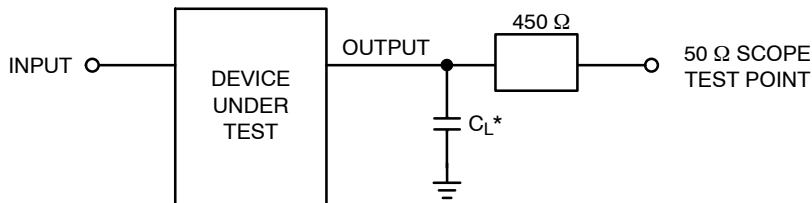


Figure 3.



\*Includes all probe and jig capacitance

Figure 4. Test Circuit

## MC74ACT640

### ORDERING INFORMATION

| Device          | Marking | Package | Shipping <sup>†</sup> |
|-----------------|---------|---------|-----------------------|
| MC74ACT640DWR2G | ACT640  | SOIC-20 | 1000 / Tape & Reel    |

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



SCALE 1:1

SOIC-20 WB  
CASE 751D-05  
ISSUE H

DATE 22 APR 2015



NOTES:

1. DIMENSIONS ARE IN MILLIMETERS.
2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS |       |
|-----|-------------|-------|
|     | MIN         | MAX   |
| A   | 2.35        | 2.65  |
| A1  | 0.10        | 0.25  |
| b   | 0.35        | 0.49  |
| c   | 0.23        | 0.32  |
| D   | 12.65       | 12.95 |
| E   | 7.40        | 7.60  |
| e   | 1.27 BSC    |       |
| H   | 10.05       | 10.55 |
| h   | 0.25        | 0.75  |
| L   | 0.50        | 0.90  |
| θ   | 0°          | 7°    |

RECOMMENDED  
SOLDERING FOOTPRINT\*



DIMENSIONS: MILLIMETERS

\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

GENERIC  
MARKING DIAGRAM\*



XXXXXX = Specific Device Code  
A = Assembly Location  
WL = Wafer Lot  
YY = Year  
WW = Work Week  
G = Pb-Free Package

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "▪", may or may not be present. Some products may not follow the Generic Marking.

|                  |             |                                                                                                                                                                                     |
|------------------|-------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| DOCUMENT NUMBER: | 98ASB42343B | Electronic versions are uncontrolled except when accessed directly from the Document Repository.<br>Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red. |
| DESCRIPTION:     | SOIC-20 WB  | PAGE 1 OF 1                                                                                                                                                                         |

onsemi and onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

**onsemi**, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at [www.onsemi.com/site/pdf/Patent-Marking.pdf](http://www.onsemi.com/site/pdf/Patent-Marking.pdf). **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

## ADDITIONAL INFORMATION

### TECHNICAL PUBLICATIONS:

Technical Library: [www.onsemi.com/design/resources/technical-documentation](http://www.onsemi.com/design/resources/technical-documentation)  
onsemi Website: [www.onsemi.com](http://www.onsemi.com)

### ONLINE SUPPORT: [www.onsemi.com/support](http://www.onsemi.com/support)

For additional information, please contact your local Sales Representative at  
[www.onsemi.com/support/sales](http://www.onsemi.com/support/sales)